

Sensors and Materials

Special Issue on International Conference on Biosensors, Bioelectronics, Biomedical Devices, BioMEMS/NEMS and Applications 2023 (Bio4Apps 2023)

CALL FOR PAPERS

Sensors and Materials is an international peer-reviewed scientific journal covering all aspects of sensor technology, including materials science as applied to sensors. **Sensors and Materials** will publish “Special issue on International Conference on Biosensors, Bioelectronics, Biomedical devices, BioMEMS/NEMS and Applications 2023 (Bio4Apps 2023)” in a 2024 or 2025 issue. We invite you to submit your work presented at the Bio4Apps 2023 as a peer-reviewed journal article in this special issue.

Scope

❖ Biosensors

- Lab-on-chip
- Miniaturized diagnostic
- Novel bioelectric sensing
- Nanophotonics/THz Sensing

❖ Bioelectronics

- Biomedical signal processing
- Body area sensor networks
- Circuits for biomedical applications/devices
- Flexible electronics
- Implantable electronics

❖ Biomedical Devices

- Bio-imaging technology
- Biocompatible materials and packaging
- Implantable medical devices
- Prosthesis and neural probes
- Surgical robots

❖ MEMS/NEMS

- MEMS/NEMS sensors and actuators
- Energy harvesting technology
- MEMS/NEMS for biomedical applications
- Microfluidics for biomedical applications

Submission Deadline: June 30, 2024

Planned Publication Date: Late 2024 or Early 2025

Journal Website: <https://sensors.myu-group.co.jp>

Guest Editors: Professor Dzung Viet Dao (Griffith University) and Dr. Cong Thanh Nguyen (Griffith University)

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